

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4299	@ad<="20030416" and (438/52). ccls. or (257/E21.218).ccls. or (438/666).ccls. or (438/702).ccls. or (438/749-750).ccls. or (438/745). ccls. or (438/739).ccls. and MEMS	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:20
L2	449	@ad<="20030416" and (438/52). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:19
L3	648	@ad<="20030416" and (438/48). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:20
L4	387	@ad<="20030416" and (438/50). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:50
L5	4285	@ad<="20030416" and (438/52). ccls. or (257/E21.218).ccls. or (438/666).ccls. or (438/702).ccls. or (438/749-750).ccls. or (438/745). ccls. or (438/739).ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:24
L6	0	@ad<="20030416" and (257/E21. 218).ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:21
L7	0	@ad<="20030416" and (438/666). ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:21
L8	3	@ad<="20030416" and (438/702). ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:22
L9	1	@ad<="20030416" and (438/749-750).ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:23
L10	1	@ad<="20030416" and (438/745). ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:24

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L11	2	@ad<="20030416" and (438/739). ccls. and MEMS same (metal with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:24
S1	14	((("5198390") or ("5316979") or ("5399415") or ("5426070") or ("5628917") or ("5846849") or ("6180536"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 13:58
S2	2	"20040207074"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 13:42
S3	1	"5876675".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:50
S4	1	"5847454".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:50
S5	1	"5690841".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:51
S6	1	"5681484".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:51
S7	1	"5426070".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:55
S8	1	"5393375".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:55
S9	1	"5198390".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:56
S10	1	"5072288".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:56
S11	1	"4980317".PN.	USPAT; USOCR	OR	ON	2005/11/18 13:57
S12	4246	@ad<="20030416" and (438/52). ccls. or (257/E21.218).ccls. or (438/666).ccls. or (438/702).ccls. or (438/749-750).ccls. or (438/745). ccls. or (438/739).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/13 10:17
S13	0	@ad<="20030416" and 'MEMS' same 'sustrate' with 'silicon' with 'metal'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:34
S14	169	@ad<="20030416" and 'MEMS' same 'substrate' with 'silicon' with 'metal'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 14:06

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S15	58	@ad<="20030416" and 'MEMS' with 'substrate' with 'silicon' with 'metal'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 14:16
S16	27	@ad<="20030416" and 'actuator' with 'substrate' with 'silicon' with 'metal'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 14:06
S18	25	@ad<="20030416" and 'MEMS' and 'metal wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 14:17
S19	941	@ad<="20030416" and 'metal wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:43
S20	471	@ad<="20030416" and 'metal' with 'wafer' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 08:02
S21	17	@ad<="20030416" and 'metal wafer' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:16
S22	70	@ad<="20030416" and 'etch' same 'metal wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:37
S23	574	@ad<="20030416" and 'etch' same 'metal substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 06:30
S24	106	@ad<="20030416" and 'metal substrate' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:38
S25	3	@ad<="20030416" and 'metal substrate' same 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:38
S26	435	@ad<="20030416" and 'metal substrate' with 'silicon substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:45

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S27	13	@ad<="20030416" and 'metal substrate' with 'silicon substrate' same 'etching'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:45
S28	10	@ad<="20030416" and 'metal substrate' with 'silicon substrate' same 'via'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:45
S29	0	@ad<="20030416" and 'metal substrate' with 'silicon substrate' same 'trench'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 04:45
S30	1	"6535474".PN.	USPAT; USOCR	OR	ON	2005/11/19 04:46
S31	1	"5422505".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:24
S32	1	"5289027".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:24
S33	1	"5198390".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:25
S34	1	"5156988".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:25
S35	1	"5072288".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:27
S36	1	"4845048".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:43
S37	1	"4814287".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:45
S38	1	"4814287".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:46
S39	1	"4776924".PN.	USPAT; USOCR	OR	ON	2005/11/19 05:46
S41	10	@ad<="20030416" and ('titanium carbide' or 'titanium boride' or 'titanium nitride') with 'substrate' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 05:59
S42	24	@ad<="20030416" and ('titanium carbide' or 'titanium boride' or 'titanium nitride') with 'substrate' same 'Microstructure'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:17
S43	1	"20020185469".PN.	US-PGPUB	OR	ON	2005/11/19 06:02
S44	1	"20010054315".PN.	US-PGPUB	OR	ON	2005/11/19 06:06
S45	1	"6208013".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:06
S46	1	"20010054315".PN.	US-PGPUB	OR	ON	2005/11/19 06:08

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S47	1	"6208013".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:08
S48	1	"6051866".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:08
S49	1	"6051866".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:08
S50	1	"6012336".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:08
S51	1	"6208013".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:10
S52	1	"5072288".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:10
S53	1	"5149673".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:10
S54	1	"6635509".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:15
S55	1	"6635509".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:19
S56	1	"6335224".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:19
S57	1	"6297072".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:19
S58	1	"6297072".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:21
S59	1	"6265246".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:21
S60	1	"6232150".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:21
S61	133	@ad<="20030416" and 'microstructure' same 'metal substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 06:44
S62	1	"20020115016".PN.	US-PGPUB	OR	ON	2005/11/19 06:34
S63	1	"20020093119".PN.	US-PGPUB	OR	ON	2005/11/19 06:35
S64	1	"6699643".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:37
S65	1	"6644537".PN.	USPAT; USOCR	OR	ON	2005/11/19 06:38
S66	2	("5,190,637").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/19 06:44
S67	17	@ad<="20030416" and 'metal wafer' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:16

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S68	0	@ad<="20030416" and 'titanium carbide' with 'substrate' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:18
S69	1337	@ad<="20030416" and 'titanium carbide' with 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:19
S70	0	@ad<="20030416" and 'titanium carbide' with 'substrate' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:19
S71	46	@ad<="20030416" and 'titanium carbide' with 'substrate' same 'via'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:25
S72	1	@ad<="20030416" and 'titanium carbide' with 'substrate' same 'trench'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:26
S73	2	@ad<="20030416" and 'titanium boride' with 'substrate' and 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:25
S74	8	@ad<="20030416" and 'titanium carbide' with 'substrate' and 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:57
S75	36	@ad<="20030416" and 'titanium nitride' with 'substrate' and 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:44
S76	1	"5072288".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:41
S77	1	"5285097".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:41
S78	1	"5316979".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:42
S79	1	"5393375".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:43
S80	8	@ad<="20030416" and 'titanium nitride' with 'substrate' and 'Nanostructures'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:53

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S81	1	"20030174384".PN.	US-PGPUB	OR	ON	2005/11/19 07:46
S82	1	"6582767".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:46
S83	1	"6521285".PN.	USPAT; USOCR	OR	ON	2005/11/19 07:46
S84	5	@ad<="20030416" and 'titanium carbide' with 'substrate' and 'Nanostructures'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:53
S85	1	@ad<="20030416" and 'titanium boride' with 'substrate' and 'Nanostructures'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:54
S86	655	@ad<="20030416" and 'metal' same 'MEMS device'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:57
S87	271	@ad<="20030416" and 'metal' with 'MEMS device'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 07:57
S88	1	@ad<="20030416" and 'metal plate' with 'MEMS device'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 08:02
S89	186	@ad<="20030416" and 'metal' with 'plate' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 08:02
S90	20	@ad<="20030416" and 'MEMS' and 'metal' with 'plate' and 'etch' same ('trench' or 'via') same 'anisotropic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/19 08:02
S92	404	@ad<="20030416" and ('titanium carbide' or 'titanium boride' or 'titanium nitride') with 'silicon' with 'wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:20
S94	24	@ad<="20030416" and 'titanium carbide' with ('wafer' or 'substrate') same 'silicon wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:27

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S95	330	@ad<="20030416" and 'titanium carbide' with ('wafer' or 'substrate') same 'silicon' with ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:28
S96	11	@ad<="20030416" and 'titanium nitride' adj1 ('wafer' or 'substrate') same 'silicon' adj1 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:28
S97	53	@ad<="20030416" and 'titanium carbide' with ('wafer' or 'substrate') same 'silicon' adj2 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 10:39
S98	8	@ad<="20030416" and 'titanium carbide' adj2 ('wafer' or 'substrate') same 'silicon' adj2 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:48
S99	1	"4923716".PN.	USPAT; USOCR	OR	ON	2005/11/21 08:32
S100	1	"4525415".PN.	USPAT; USOCR	OR	ON	2005/11/21 08:34
S101	1	"4923716".PN.	USPAT; USOCR	OR	ON	2005/11/21 08:34
S102	1	"4810526".PN.	USPAT; USOCR	OR	ON	2005/11/21 08:34
S103	1	"4459338".PN.	USPAT; USOCR	OR	ON	2005/11/21 08:34
S104	59	@ad<="20030416" and 'titanium nitride' adj2 ('wafer' or 'substrate') same 'silicon' adj2 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:36
S105	1	@ad<="20030416" and 'titanium boride' adj2 ('wafer' or 'substrate') same 'silicon' adj2 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:35
S106	11	@ad<="20030416" and 'titanium nitride' adj1 ('wafer' or 'substrate') same 'silicon' adj1 ('wafer' or 'substrate')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:36
S107	271	'Bunshah Rointan' or 'Parsons James' or 'Stafsudd Oscar' and 'titanium'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:50

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S10 8	270	'Bunshah Rointan' or 'Parsons James' or 'Stafsudd Oscar' and 'titanium' adj3 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:50
S10 9	270	'Bunshah Rointan' or 'Parsons James' or 'Stafsudd Oscar' and 'titanium' adj2 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:55
S11 0	270	'Bunshah Rointan' or 'Parsons James' or 'Stafsudd Oscar' and 'titanium carbide'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:55
S11 1	9	('Bunshah Rointan' or 'Parsons James' or 'Stafsudd Oscar') and 'titanium carbide'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 08:56
S11 2	2	("6643099").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/21 10:15
S11 3	2	("6768628").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/21 10:28
S11 4	2	("6875475").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/21 10:36
S11 5	1	@ad<="20030416" and 'titanium carbide substrate' same 'silicon substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 10:40
S11 6	1	@ad<="20030416" and 'titanium carbide wafer' same 'silicon wafer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 10:40
S11 7	440	@ad<="20030416" and (438/52). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON.	2006/05/13 10:17

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S11 8	1	@ad<="20030416" and (438/52). ccls. and 'TiC'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 10:55
S11 9	4	@ad<="20030416" and (438/52). ccls. and 'Titanium carbide'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:05
S12 0	380	@ad<="20030416" and (438/50). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:05
S12 1	28	@ad<="20030416" and (438/52). ccls. and 'TiN'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:07
S12 2	580	@ad<="20030416" and (438/53). ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:31
S12 6	47	@ad<="20030416" and 'MEMS' same 'TiN' same 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:35
S12 7	11	@ad<="20030416" and 'MEMS' same 'TiN' with 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:35
S12 8	0	@ad<="20030416" and 'MEMS' same 'Titanium carbide' with 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:04
S12 9	10	@ad<="20030416" and 'MEMS' same 'Titanium nitride' with 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:35
S13 0	0	@ad<="20030416" and 'MEMS' same 'Titanium boride' with 'substrate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 11:35
S13 1	1	@ad<="20030416" and 'reactive ion etching' same 'oxidation plasma' same 'etching plasma'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:20

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S13 3	20	@ad<="20030416" and 'anisotropic' same 'reactive ion etching' and 'oxidation plasma'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:12
S13 5	14455	@ad<="20030416" and ('Metal Anisotropic Reactive Ion etching with Oxidation' or 'MARIO')	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:15
S13 6	1	'Metal Anisotropic Reactive Ion etching' with 'Oxidation'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:18
S13 7	1	'RIE' same 'MARIO'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:18
S13 8	1	'MARIO' same 'etching'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:18
S13 9	0	@ad<="20030416" and 'stacking MEMS' same 'encapsulate'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:20
S14 0	40	@ad<="20030416" and 'stacking' with 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:33
S14 1	11	@ad<="20030416" and 'enclose' same 'stack' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:35
S14 2	1	@ad<="20030416" and 'enclosure' same 'stack' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:35
S14 3	0	@ad<="20030416" and 'encap' same 'stack' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:35
S14 4	13	@ad<="20030416" and 'protect' same 'stack' same 'MEMS'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/21 13:36